

## Frequently Asked Questions

Debt Securities
(For Debt Issues to Professional Investors Only)

MayJuly 2024



## DS2-4 How should documents be submitted to the Exchange by electronic means under the paperless regime?

The Exchange will establish a new online platform (**Issuer Platform**) as a designated channel for two-way communication between the Listing Division and new applicants/ listed issuers (except for structured products issuers). New applicants/ listed issuers and their professional parties will be able to use this platform to submit all documents and e-Forms to the Division electronically. The Exchange will update the market prior to the launch of the Issuer Platform, with necessary guidance.

Until that time, new applicants and listed issuers (and their advisors) should continue to submit documents to the Listing Division through the existing permitted electronic means (e.g. by email or via HKEX-ESS).

MB Rule 2.07(3A) GEM Rule 2.21

First released: December 2023; last updated: May 2024

## DS2-5 <u>Is digital signature required for documents electronically submitted to the Exchange that require signature?</u>

No, except for documents that are to be electronically submitted to the Exchange for the purpose of authorisation of prospectus registration under the Companies (Winding Up and Miscellaneous Provisions) Ordinance.

MB Rules 1.02A and 2.07(3A)

GEM Rules 1.03A and 2.21

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